

Intel[®] Core[™] i7 Processor Family for LGA2011-v3 Socket

Specification Update

Supporting Desktop Intel[®] Core[™] i7-5960X Extreme Edition Processor Series for the LGA2011-v3 Socket

Supporting Desktop Intel[®] Core[™] i7-59xx and i7-58xx Processor Series for the LGA2011-v3 Socket

August 2014



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Revision History

Version	Description	Date
001	Initial release.	August 2014

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Preface

This document is an update to the specifications contained in the [Affected documents](#) table below. This document is a compilation of device and documentation errata, specification clarifications, and changes. It is intended for hardware system manufacturers and software developers of applications, operating systems, or tools.

Information types defined in [Nomenclature](#) are consolidated into the specification update and are no longer published in other documents.

This document may also contain information that was not previously published.

Note: Throughout this document, the Intel® Core™ i7 processor family may be referred to as “processor”.

Affected documents

Document Title	Document Number / Location
Intel® Core™ i7 Processor Family for LGA2011-v3 Socket Datasheet – Volume 1 of 2	330839
Intel® Core™ i7 Processor Family for LGA2011-v3 Socket Datasheet – Volume 2 of 2	330840

Related documents

Document Title	Document Number / Location
<i>AP-485, Intel® Processor Identification and the CPUID Instruction</i>	241618
<ul style="list-style-type: none">• <i>Intel® 64 and IA-32 Architectures Software Developer’s Manual, Volume 1: Basic Architecture</i>• <i>Intel® 64 and IA-32 Architectures Software Developer’s Manual, Volume 2A: Instruction Set Reference Manual A-M</i>• <i>Intel® 64 and IA-32 Architectures Software Developer’s Manual, Volume 2B: Instruction Set Reference Manual N-Z</i>• <i>Intel® 64 and IA-32 Architectures Software Developer’s Manual, Volume 3A: System Programming Guide</i>• <i>Intel® 64 and IA-32 Architectures Software Developer’s Manual, Volume 3B: System Programming Guide</i>• <i>Intel® 64 and IA-32 Intel Architecture Optimization Reference Manual</i>	http://www.intel.com/products/processor/manuals/index.htm



Nomenclature

Errata are design defects or errors. These may cause the processor behavior to deviate from published specifications. Hardware and software designed to be used with any given stepping must assume that all errata documented for that stepping are present on all devices.

S-Spec Number is a five-digit code used to identify products. Products are differentiated by their unique characteristics such as, core speed, L2 cache size, package type, etc. as described in the processor identification information table. Read all notes associated with each S-Spec number.

Specification changes are modifications to the current published specifications. These changes will be incorporated in any new release of the specification.

Specification clarifications describe a specification in greater detail or further highlight a specification's impact to a complex design situation. These clarifications will be incorporated in any new release of the specification.

Documentation changes include typos, errors, or omissions from the current published specifications. These will be incorporated in any new release of the specification.

Note: Errata remain in the specification update throughout the product's lifecycle, or until a particular stepping is no longer commercially available. Under these circumstances, errata removed from the specification update are archived and available upon request. Specification changes, specification clarifications and documentation changes are removed from the specification update when the appropriate changes are made to the appropriate product specification or user documentation (datasheets, manuals, etc.).

Identification Information

Component Identification using Programming Interface

The processor stepping can be identified by the following register contents.

Table 1. Processor Signature / Version

Reserved	Extended family ¹	Extended model ²	Reserved	Processor type	Family code ³	Model number ⁴	Stepping ID ⁵
31:28	27:20	19:16	15:14	13:12	11:8	7:4	3:0
	00000000b	0011b		00b	0110b	1111b	0010

Notes:

1. The Extended Family, Bits [27:20] are used in conjunction with the Family Code, specified in Bits [11:8], to indicate whether the processor belongs to the Intel386™, Intel486™, Pentium®, Pentium 4, or Intel® Core™ processor family.
2. The Extended Model, Bits [19:16] in conjunction with the Model Number, specified in Bits [7:4], are used to identify the model of the processor within the processor's family.
3. The Family Code corresponds to Bits [11:8] of the EDX register after RESET, Bits [11:8] of the EAX register after the CPUID instruction is executed with a 1 in the EAX register, and the generation field of the Device ID register accessible through Boundary Scan.
4. The Model Number corresponds to Bits [7:4] of the EDX register after RESET, Bits [7:4] of the EAX register after the CPUID instruction is executed with a 1 in the EAX register, and the model field of the Device ID register accessible through Boundary Scan.
5. The Stepping ID in Bits [3:0] indicates the revision number of that model.

Component Marking

The processor stepping can be identified by the following component markings.

Figure 1. Processor Top-side Markings (example)

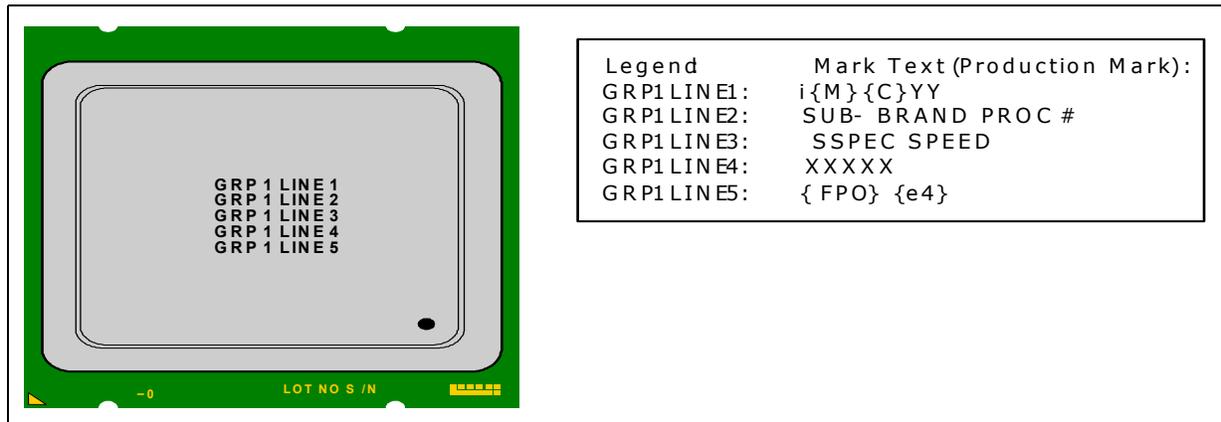


Table 2. Processor Family identification

S-spec number	Processor Number	Stepping	CPUID	Max Turbo Frequency (GHz)	Memory Frequency (MHz)	TDP (W)	# Cores	Cache size (MB)
R20Q	i7-5960X	R-2	000306F2h	3.5	2133	140	8	20
R20R	i7-5930K	R-2	000306F2h	3.7	2133	140	6	15
R20S	i7-5820K	R-2	000306F2h	3.6	2133	140	6	15



Summary Tables of Changes

The following tables indicate the errata, specification changes, specification clarifications, or documentation changes that apply to the processor product. Intel may fix some of the errata in a future stepping of the component, and account for the other outstanding issues through documentation or specification changes as noted. These tables use the following notations:

Codes used in summary tables

Stepping

- X: Errata exists in the stepping indicated. Specification Change or Clarification that applies to this stepping.
- (No mark)
or (Blank box): This erratum is fixed in listed stepping or specification change does not apply to listed stepping.

Page

- (Page): Page location of item in this document.

Status

- Doc: Document change or update will be implemented.
- Plan Fix: This erratum may be fixed in a future stepping of the product.
- Fixed: This erratum has been previously fixed.
- No Fix: There are no plans to fix this erratum.

Row



Change bar to left of table row indicates this erratum is either new or modified from the previous version of the document.



Table 3. Errata

Number	Stepping	Status	ERRATA
	R-2		
HSH1	X	No Fix	Intel® QPI Layer May Report Spurious Correctable Errors
HSH2	X	No Fix	NTB May Incorrectly Set MSI or MSI-X Interrupt Pending Bits
HSH3	X	No Fix	Memory Controller May Incorrectly Issue a Refresh Command Immediately After a Precharge Command
HSH4	X	No Fix	Processor May Issue Unexpected NAK DLLP Upon PCIe* L1 Exit
HSH5	X	No Fix	PECI DDR DIMM Digital Thermal Reading Returns Incorrect Value
HSH6	X	No Fix	IIO CSR Lnkcon2 Field Selectable_De_Emphasis Cannot Be Set For DMI2 Mode
HSH7	X	No Fix	PCIe* Receiver May Not Meet the Specification for AC Common Mode Voltage And Jitter
HSH8	X	No Fix	Receiver Termination Impedance On PCIe* 3.0 Does Not Comply With The Specification
HSH9	X	No Fix	USB3 xHCI Not compatible with MSIs
HSH10	X	No Fix	Writing R3QPI Performance Monitor Registers May Fail
HSH11	X	No Fix	CPUID Extended Topology Enumeration Leaf May Indicate an Incorrect Number of Logical Processors
HSH12	X	No Fix	Intel QPI Link Re-training After a Warm Reset or L1 Exit May be Unsuccessful
HSH13	X	No Fix	VCCIN VR Phase Shedding is Disabled
HSH14	X	No Fix	Possible Non-Optimal Electrical Margins on The DDR Command Bus
HSH15	X	No Fix	PECI Commands During Reset May Result in Persistent Timeout Response
HSH16	X	No Fix	System May Hang When Using the TPH Prefetch Hint
HSH17	X	No Fix	TS1s Do Not Convey The Correct Transmitter Equalization Values During Recovery.RcvrLock
HSH18	X	No Fix	MSR_TEMPERATURE_TARGET MSR May Read as '0'
HSH19	X	No Fix	PECI RdIAMS() Command May Fail After Core C6 State is Entered
HSH20	X	No Fix	CLTT May Cause BIOS To Hang On a Subsequent Warm Reset
HSH21	X	No Fix	DDR4 Power Down Timing Violation
HSH22	X	No Fix	PCIe* Extended Tag Field May be Improperly Set
HSH23	X	No Fix	A MOV to CR3 When EPT is Enabled May Lead to an Unexpected Page Fault or an Incorrect Page Translation
HSH24	X	No Fix	The System May Hang When a C/A Parity Error is Detected
HSH25	X	No Fix	A C/A Parity Error When DDR4 is Operating at 2133 MHz May Result in Unpredictable System Behavior
HSH26	X	No Fix	Enabling Isochronous Transfers May Result in Unpredictable System Behavior
HSH27	X	No Fix	Enabling Secondary To Primary Snoop Overrides On NTB May Cause a Hang
HSH28	X	No Fix	Memory Controller tsod_present Settings Being Improperly Cleared
HSH29	X	No Fix	Reserving Resources For Isochronous Transfers With Non-Posted Prefetching Enabled May Cause a Hang
HSH30	X	No Fix	BT Timeouts May Cause Spurious Machine Checks
HSH31	X	No Fix	Full Duplex NTB Traffic Can Cause a System Hang
HSH32	X	No Fix	CONFIG_TDP_NOMINAL CSR Implemented at Incorrect Offset
HSH33	X	No Fix	Software Using Intel® Transactional Synchronization Extensions (Intel® TSX) May Result in Unpredictable System Behavior
HSH34	X	No Fix	A Machine-Check Exception Due to Instruction Fetch May Be Delivered Before an Instruction Breakpoint



Table 4. Specification clarifications

No.	Specification clarifications
	None

Table 5. Specification Changes

No.	Specification changes
	None

Table 6. Documentation Changes

No.	Documentation changes
	None



Errata

HS#1 Intel® QPI Layer May Report Spurious Correctable Errors

Problem: Intel QPI may report an inband reset with no width change (error 0x22) correctable error upon exit from the L1 power state as logged in its IA32_MC{5, 20, 21}_STATUS MSRs (415H,451H,455H).

Implication: An unexpected inband reset with no width change error may be logged.

Workaround: A BIOS code change has been identified and may be implemented as a workaround for this erratum.

Status: For the affected steppings, see the Summary Tables of Changes.

HS#2 NTB May Incorrectly Set MSI or MSI-X Interrupt Pending Bits

Problem: The NTB (Non-transparent Bridge) may incorrectly set MSI (Message Signaled Interrupt) pending bits in MSIPENDING (BAR PB01BASE,SB01BASE; Offset 74H) while operating in MSI-X mode or set MSI-X pending bits in PMSIXPBA (BAR PB01BASE, SB01BASE; Offset 03000H) while operating in MSI mode.

Implication: Due to this erratum, NTB incorrectly sets MSI or MSI-X pending bits. The correct pending bits are also set and it is safe to ignore the incorrectly set bits.

Workaround: None identified.

Status: For the affected steppings, see the Summary Tables of Changes.

HS#3 Memory Controller May Incorrectly Issue a Refresh Command Immediately After a Precharge Command

Problem: In PPD (Precharge Power Down) mode, the memory controller may incorrectly issue a REF (refresh) command one cycle after a PREA (precharge) command, violating JEDEC specifications.

Implication: Memory contents may be affected in precharge Power Down mode leading to unpredictable system behavior.

Workaround: A BIOS code change has been identified and may be implemented as a workaround for this erratum

Status: For the affected steppings, see the Summary Tables of Changes.

HS#4 Processor May Issue Unexpected NAK DLLP Upon PCIe* L1 Exit

Problem: Upon exiting the L1 link power state, the processor's PCIe port may unexpectedly issue a NAK DLLP (Data Link Layer Packet).

Implication: PCIe endpoints may unexpectedly receive and log a NAK DLLP.

Workaround: None identified.

Status: For the affected steppings, see the Summary Tables of Changes.

HS#5 PECCI DDR DIMM Digital Thermal Reading Returns Incorrect Value

Problem: When using the PECCI RdPkgConfig() command to read PCS (Package Config Space) Service 14 "DDR DIMM Digital Thermal Reading", the value returned is incorrect.

Implication: Platform thermal management may not behave as expected.

Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Status: For the affected steppings, see the Summary Tables of Changes.



HSH6 IIO CSR Lnkcon2 Field Selectable_De_Emphasis Cannot Be Set For DMI2 Mode

Problem: The CSR Lnkcon2 (Bus 0; Device 0; Function 0, Offset 0x1C0) field selectable_de_emphasis (bit 6) cannot be set for a link in DMI2 Mode when the DMI port is operating at 5 GT/s. The documentation has the attribute of RW-O (read, write once), but the processor incorrectly operates as read-only.

Implication: When the link is in DMI2 mode, the de-emphasis cannot be changed for an upstream component.

Workaround: None identified.

Status: For the affected steppings, see the Summary Tables of Changes.

HSH7 PCIe* Receiver May Not Meet the Specification for AC Common Mode Voltage And Jitter

Problem: Due to this erratum, PCIe receivers may not meet the specification for AC common mode voltage (300 mV) and jitter (78.1 ps) at high temperatures when operating at 5 GT/s.

Implication: Specifications for PCIe receiver AC common mode voltage and jitter may not be met. Intel has not observed this erratum on any commercially available system with any commercially available PCIe devices.

Workaround: None identified.

Status: For the affected steppings, see the Summary Tables of Changes.

HSH8 Receiver Termination Impedance On PCIe* 3.0 Does Not Comply With The Specification

Problem: The PCIe* Base Specification revision 3.0 defines ZRX-HIGH-IMP-DC-NEG and ZRX-HIGH-IMP-DC-POS for termination impedance of the receiver. The specified impedance for a negative voltage (-150 mV to 0V) is expected to be greater than 1 Kohm. Sampled measurements of this impedance as low as 400 ohms have been seen. The specified impedance for a positive voltage (> 200 mV) is greater than 20 Kohms. Sampled measurements of this impedance as low as 14.6 Kohms have been seen.

Implication: Intel has not observed functional failures from this erratum on any commercially available platforms using any commercially available PCIe device.

Workaround: None identified.

Status: For the affected steppings, see the Summary Tables of Changes.

HSH9 USB3 xHCI Not compatible with MSIs

Problem: When the PCH xHCI (Extensible Host Controller Interface) is configured to use MSI interrupts, a PCIe device number conflict between the processor and xHCI controller may cause the interrupts be routed incorrectly.

Implication: Due to this erratum, unpredictable system behavior may result.

Workaround: A BIOS code change has been identified and may be implemented as a workaround for this erratum.

Status: For the affected steppings, see the Summary Tables of Changes.

HSH10 Writing R3QPI Performance Monitor Registers May Fail

Problem: Due to this erratum, attempting to write R3QPI performance monitor registers (Bus 0; Device 11; Functions 1,2,5,6; Offset 0xA0-0xF7) may be unsuccessful.

Implication: A failed write to one or more R3QPI performance monitor registers is likely to yield incorrect performance events counts.

Workaround: Consecutively write the identified registers twice with the same value before performance monitoring is globally enabled.

Status: For the affected steppings, see the Summary Tables of Changes.



HS11 CPUID Extended Topology Enumeration Leaf May Indicate an Incorrect Number of Logical Processors

Problem: The Extended Topology Enumeration Leaf of CPUID (EAX = 0xB) may return an incorrect value in EBX[15:0] for the core level type (ECX[15:8] = 2). In this instance, the number of logical processors at the core level reported in EBX[15:0] should reflect the configuration as shipped by Intel.

Implication: Software that uses the referenced CPUID function may not properly initialize all logical processors in the system or correctly report the actual number of factory-configured logical processors.

Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Status: For the affected steppings, see the Summary Tables of Changes.

HS12 Intel QPI Link Re-training After a Warm Reset or L1 Exit May be Unsuccessful

Problem: After a warm reset or an L1 exit, the Intel® QPI (Intel QuickPath Interconnect) links may not train successfully.

Implication: A failed Intel QPI link can lead to reduced system performance or an inoperable system.

Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Status: For the affected steppings, see the Summary Tables of Changes.

HS13 VCCIN VR Phase Shedding is Disabled

Problem: Due to this erratum, the processor does not direct the VCCIN VR (voltage regulator) to shed phases during low power states.

Implication: Platform power consumption may exceed expected levels during deep package C-states.

Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Status: For the affected steppings, see the Summary Tables of Changes.

HS14 Possible Non-Optimal Electrical Margins on The DDR Command Bus

Problem: The processor periodically adjusts drive strength for DDR signals to optimize electrical margins. Due to this erratum, the drive strength on the DDR command bus may be incorrectly adjusted.

Implication: Reduced electrical margins on the command bus can lead to higher error rates possibly affecting system stability.

Workaround: A BIOS code change has been identified and may be implemented as a workaround for this erratum.

Status: For the affected steppings, see the Summary Tables of Changes.

HS15 PECE Commands During Reset May Result in Persistent Timeout Response

Problem: Due to this erratum, a PECE (Platform Environment Control Interface) command other than GetDIB(), Ping(), or GetTemp() received before RESET_N is de-asserted may result in a timeout (0x81 completion code) for all subsequent such commands.

Implication: Future PECE commands other than GetDIB(), Ping(), and GetTemp() will not be serviced after this erratum occurs.

Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Status: For the affected steppings, see the Summary Tables of Changes.



HS16 System May Hang When Using the TPH Prefetch Hint

Problem: When all enabled cores on a socket are simultaneously in core C3, core C6, or package C6 state and a PCIe* TPH (Transaction layer packet Processing Hint) with the prefetch hint set is received, the system may hang.

Implication: Due to this erratum, the system may hang.

Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Status: For the affected steppings, see the Summary Tables of Changes.

HS17 TS1s Do Not Convey The Correct Transmitter Equalization Values During Recovery.RcvrLock

Problem: The PCIe* 3.1 Base Specification requires that TS1s sent during Recovery.RcvrLock following 8.0 GT/s EQ (adaptive equalization) contain the final transmitter preset number and coefficient values that were requested by an endpoint during phase 2 of EQ. Due to this erratum, TS1s with incorrect transmitter preset number values may be sent during Recovery.RcvrLock following 8.0 GT/s adaptive equalization.

Implication: Endpoints that check these values may, when unexpected values are found, request equalization restart in subsequent TSs it sends. If EQ requests from the endpoint are supported in the BIOS or OS, EQ will be restarted and the link may continue this EQ loop indefinitely.

Workaround: None identified.

Status: For the affected steppings, see the Summary Tables of Changes.

HS18 MSR_TEMPERATURE_TARGET MSR May Read as '0'

Problem: Due to this erratum, reading the MSR_TEMPERATURE_TARGET MSR (1A2H) may incorrectly return '0'.

Implication: Software that depends on the contents of the MSR_TEMPERATURE_TARGET MSR may not behave as expected.

Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Status: For the affected steppings, see the Summary Tables of Changes.

HS19 PECCI RdIAMSRR() Command May Fail After Core C6 State is Entered

Problem: Reading core Machine Check Bank registers using the PECCI (Platform Environment Control Interface) RdIAMSRR() command may fail after core C6 state has been entered.

Implication: Invalid data may be returned when using PECCI to read core Machine Check Bank registers.

Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Status: For the affected steppings, see the Summary Tables of Changes.

HS20 CLTT May Cause BIOS To Hang On a Subsequent Warm Reset

Problem: If CLTT (Closed Loop Thermal Throttling) is enabled when a warm reset is requested, due to this erratum, the processor will resume DIMM temperature polling before the memory sub-system has been re-initialized.

Implication: This erratum may lead to a BIOS hang. The warm reset request will fail, along with subsequent warm reset attempts. The failing condition is cleared by a cold reset.

Workaround: A BIOS workaround has been identified. Please refer to the latest version of the Platform Reference Code (RC).

Status: For the affected steppings, see the Summary Tables of Changes.



HS21 DDR4 Power Down Timing Violation

Problem: When DDR4 is operating at 2133 MHz, the processor's memory control may violate the JEDEC tPRPDEN timing specification.

Implication: Intel has not observed this erratum to impact the operation of any commercially available system

Workaround: None identified.

Status: For the affected steppings, see the Summary Tables of Changes.

HS22 PCIe* Extended Tag Field May be Improperly Set

Problem: The Extended Tag field in the TLP Header will not be zero for TLPs issued by PCIe ports 1a, 1b, 2c, 2d, 3c, and 3d even when the Extended Tag Field Enable bit in the Device Control Register (Offset 08H, bit 8) is 0.

Implication: This does not affect ports 0, 2a, 2b, 3a and 3b. This will not result in any functional issues when using device that properly track and return the full 8 bit Extended Tag value with the affected ports. However, if the Extended Tag field is not returned by a device connected to an affected port then this may result in unexpected completions and completion timeouts.

Workaround: None identified.

Status: For the affected steppings, see the Summary Tables of Changes.

HS23 A MOV to CR3 When EPT is Enabled May Lead to an Unexpected Page Fault or an Incorrect Page Translation

Problem: If EPT (extended page tables) is enabled, a MOV to CR3 may be followed by an unexpected page fault or the use of an incorrect page translation.

Implication: Guest software may crash or experience unpredictable behavior as a result of this erratum.

Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Status: For the affected steppings, see the Summary Tables of Changes.

HS24 The System May Hang When a C/A Parity Error is Detected

Problem: Due to this erratum, detection of a C/A (Command/Address) parity error by the memory controller can lead to a system hang.

Implication: System may experience a hang condition in the presence of C/A parity errors.

Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Status: For the affected steppings, see the Summary Tables of Changes.

HS25 A C/A Parity Error When DDR4 is Operating at 2133 MHz May Result in Unpredictable System Behavior

Problem: Due to this erratum, when DDR4 is operating at 2133MHz and a C/A (Command/Address) parity error occurs while exiting a package C-state then unpredictable system behavior may occur.

Implication: Due to this erratum, the system may experience unpredictable system behavior.

Workaround: A BIOS code change has been identified and may be implemented as a workaround for this erratum.

Status: For the affected steppings, see the Summary Tables of Changes.



HS26 Enabling Isochronous Transfers May Result in Unpredictable System Behavior

- Problem:** Enabling isochronous transfers may lead to spurious correctable memory errors, uncorrectable memory errors, patrol scrub errors and unpredictable system behavior.
- Implication:** The system may hang, or report spurious memory errors, or behave unpredictably.
- Workaround:** A BIOS code change has been identified and may be implemented as a workaround for this erratum.
- Status:** For the affected steppings, see the Summary Tables of Changes.

HS27 Enabling Secondary To Primary Snoop Overrides On NTB May Cause a Hang

- Problem:** Due to this erratum, NTB (Non-Transparent Bridge) completions may be dropped when Secondary to Primary Snoop Overrides are enabled.
- Implication:** The system may hang or experience timeout machine checks when the secondary to primary snoop override is enabled. This erratum does not affect primary to secondary snoop override.
- Workaround:** None identified. To avoid this erratum, set the bar45_s2p_snpov field (bits[7:6]) and the bar23_s2p_snpov field (bits[3:2]) of the ntbcntl CSR (Bus: 0; Device: 3; Function: 0; Offset: 0x58) to 0.
- Status:** For the affected steppings, see the Summary Tables of Changes.

HS28 Memory Controller tsod_present Settings Being Improperly Cleared

- Problem:** On single Home Agent configurations, due to this erratum, the processor interferes with TSOD (thermal sensor on DIMM) usage by incorrectly clearing the tsod_present field (bits[7:0]) of the smbcntl_1 CSR (Bus 0; Device 19; Function 0; Offset 0x198) after BIOS writes that field.
- Implication:** Closed Loop Thermal Throttle will not work as expected.
- Workaround:** It is possible for the BIOS to contain a workaround for this erratum.
- Status:** For the affected steppings, see the Summary Tables of Changes.

HS29 Reserving Resources For Isochronous Transfers With Non-Posted Prefetching Enabled May Cause a Hang

- Problem:** Resources in the IIO (Integrated I/O) unit are reserved for isochronous transfers to ensure performance guarantees are met. Due to this erratum, enabling non-posted prefetching in the IIO when resources are reserved for isochronous traffic may result in a hang.
- Implication:** Due to this erratum, configuring the IIO unit to prefetch may result in a system hang.
- Workaround:** A BIOS code change has been identified and may be implemented as a workaround for this erratum.
- Status:** For the affected steppings, see the Summary Tables of Changes.

HS30 BT Timeouts May Cause Spurious Machine Checks

- Problem:** The BT (Backup Tracker) timeout logic in the Home Agent can trigger spuriously, causing false machine checks indicated by IA32_MCI_STATUS.MSCOD=0x0200.
- Implication:** Due to this erratum, timeout machine check may occur.
- Workaround:** It is possible for the BIOS to contain a workaround for this erratum.
- Status:** For the affected steppings, see the Summary Tables of Changes.



HSB31 Full Duplex NTB Traffic Can Cause a System Hang

Problem: If two PCIe* endpoints target traffic to PB23BASE (Bus 0; Device 3; Function 0; Offset 0x18, 0x1c) and PB45BASE (Bus 0; Device 3; Function 0; Offset 0x20, 0x24) registers at the same time, a deadlock can result.

Implication: Due to this erratum, the system may hang.

Workaround: A BIOS code change has been identified and may be implemented as a workaround for this erratum.

Status: For the affected steppings, see the Summary Tables of Changes.

HSB32 CONFIG_TDP_NOMINAL CSR Implemented at Incorrect Offset

Problem: The PCIe* Base Specification indicates that Configuration Space Headers have a base address register at offset 0x10. Due to this erratum, the Power Control Unit's CONFIG_TDP_NOMINAL CSR (Bus 1; Device 30; Function 3; Offset 0x10) is located where a base address register is expected.

Implication: Software may treat the CONFIG_TDP_NOMINAL CSR as a base address register leading to a failure to boot.

Workaround: None identified.

Status: For the affected steppings, see the Summary Tables of Changes.

HSB33 Software Using Intel® Transactional Synchronization Extensions (Intel® TSX) May Result in Unpredictable System Behavior

Problem: Under a complex set of internal timing conditions and system events, software using the Intel TSX instructions may result in unpredictable system behavior.

Implication: This erratum may result in unpredictable system behavior.

Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Status: For the affected steppings, see the Summary Tables of Changes.

HSB34 A Machine-Check Exception Due to Instruction Fetch May Be Delivered Before an Instruction Breakpoint

Problem: from fetching an instruction. Due to this erratum, a machine-check exception resulting from the fetch of an instruction may take priority over an instruction breakpoint if the instruction crosses a 32-byte boundary and the second part of the instruction is in a 32-byte poisoned instruction fetch block.

Implication: Instruction breakpoints may not operate as expected in the presence of a poisoned instruction fetch block.

Workaround: None identified.

Status: For the affected steppings, see the Summary Tables of Changes.



Specification Changes

There are no specification changes in this specification update revision.



Specification Clarifications

There are no specification clarifications in this specification update revision.

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Documentation Changes

The Documentation Changes listed in this section apply to the following documents:

- Intel® 64 and IA-32 Architectures Software Developer's Manual, Volume 1: Basic Architecture
- Intel® 64 and IA-32 Architectures Software Developer's Manual, Volume 2A: Instruction Set Reference Manual A-M
- Intel® 64 and IA-32 Architectures Software Developer's Manual, Volume 2B: Instruction Set Reference Manual N-Z
- Intel® 64 and IA-32 Architectures Software Developer's Manual, Volume 3A: System Programming Guide
- Intel® 64 and IA-32 Architectures Software Developer's Manual, Volume 3B: System Programming Guide

All Documentation Changes will be incorporated into a future version of the appropriate Processor documentation.

Note: Documentation changes for Intel® 64 and IA-32 Architecture Software Developer's Manual volumes 1, 2A, 2B, 3A, and 3B will be posted in a separate document, Intel® 64 and IA-32 Architecture Software Developer's Manual Documentation Changes. Follow the link below to become familiar with this file.

<http://developer.intel.com/products/processor/manuals/index.htm>

There are no documentation changes in this specification update revision.

